

# GB01SLT12-220

# Silicon Carbide Power **Schottky Diode**

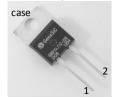
$V_{RRM}$	=	1200 V
$V_{F}$	=	1.6 V
I <sub>F</sub>	=	1 A
$\mathbf{Q}_{C}$	=	13 nC

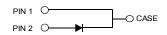
## **Features**

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- · Superior surge current capability
- Positive temperature coefficient of V<sub>F</sub>
- · Extremely fast switching speeds
- Superior figure of merit Q<sub>C</sub>/I<sub>F</sub>

# **Package**

RoHS Compliant





TO - 220AC

## **Advantages**

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- · Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

# **Applications**

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

# Maximum Ratings at T<sub>i</sub> = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	$V_{RRM}$		1200	V
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 160 °C	1	Α
RMS forward current	I <sub>F(RMS)</sub>	T <sub>C</sub> ≤ 160 °C	2	Α
Surge non-repetitive forward current, Half Sine		$T_C$ = 25 °C, $t_P$ = 10 ms	10	Λ
Wave	I <sub>F,SM</sub>	$T_C = 160 ^{\circ}\text{C},  t_P = 10 \text{ms}$	8	Α
Non-repetitive peak forward current	$I_{F,max}$	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 $\mu {\rm s}$	65	Α
l <sup>2</sup> t value	∫i² dt	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	0.5	A <sup>2</sup> s
i i value		$T_C$ = 160 °C, $t_P$ = 10 ms	0.3	AS
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> = 25 °C	42	W
Operating and storage temperature	$T_{j}$ , $T_{stg}$		-55 to 175	°C

# Electrical Characteristics at T<sub>i</sub> = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions -			Values		Unit
Parameter	Syllibol			min.	typ.	max.	Ullit
Diode forward voltage	V <sub>F</sub>	I <sub>F</sub> = 1 A, T <sub>j</sub> = 25 °C		1.50	1.56	1.75	V
Diode forward voltage	VF	I <sub>F</sub> = 1 A, T <sub>j</sub> = 175 °C		2.29	2.39	3.68	
Reverse current	1	$V_R = 1200 \text{ V}, T_j$	= 25 °C	0.2	0.4	4.5	
Reverse current	I <sub>R</sub>	$V_R = 1200 \text{ V}, T_j =$	= 175 °C	0.5	1.0	11.3	μA
Total canacitive charge	0		V <sub>R</sub> = 400 V		7		nC
Total capacitive charge	$Q_{C}$	$I_F \le I_{F,MAX}$	V <sub>R</sub> = 960 V		13		IIC
Switching time	4	dl <sub>F</sub> /dt = 200 A/μs T <sub>i</sub> = 175 °C	V <sub>R</sub> = 400 V		< 17		no
Switching time	$t_s$	1, 1100	V <sub>R</sub> = 960 V		<b>\ 11</b>		ns
		V <sub>R</sub> = 1 V, f = 1 MHz	, T <sub>j</sub> = 25 °C		69		
Total capacitance	С	$V_R = 400 \text{ V}, f = 1 \text{ MH}$	z, T <sub>j</sub> = 25 °C		10		pF
		$V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		8			

#### **Thermal Characteristics**

Thermal resistance, junction - case	R <sub>thJC</sub>	3.6	°C/W
Mechanical Properties			
Mounting torque	M	0.6	Nm



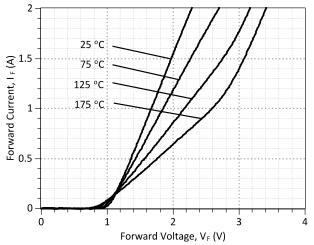


Figure 1: Typical Forward Characteristics

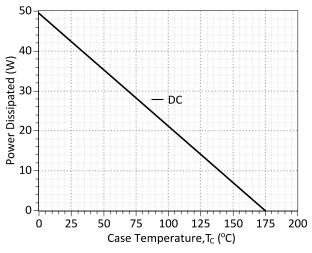


Figure 3: Power Derating Curve

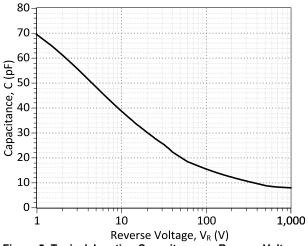


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

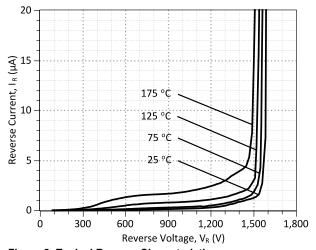


Figure 2: Typical Reverse Characteristics

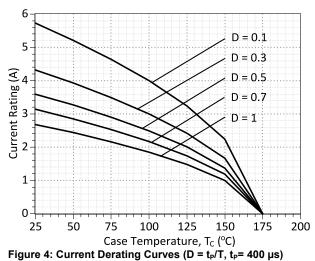


Figure 4: Current Derating Curves (D =  $t_P/T$ ,  $t_P$ = 400  $\mu$ s) (Considering worst case  $Z_{th}$  conditions)

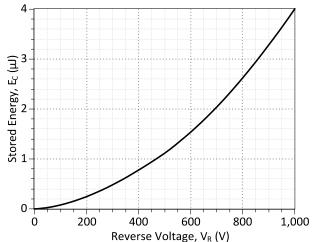


Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics



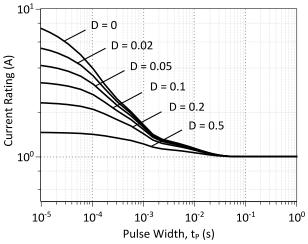


Figure 7: Current vs Pulse Duration Curves at T<sub>c</sub> = 160 °C

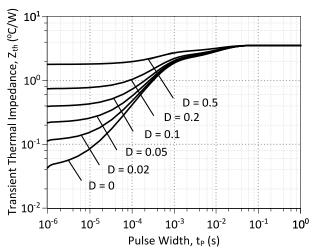
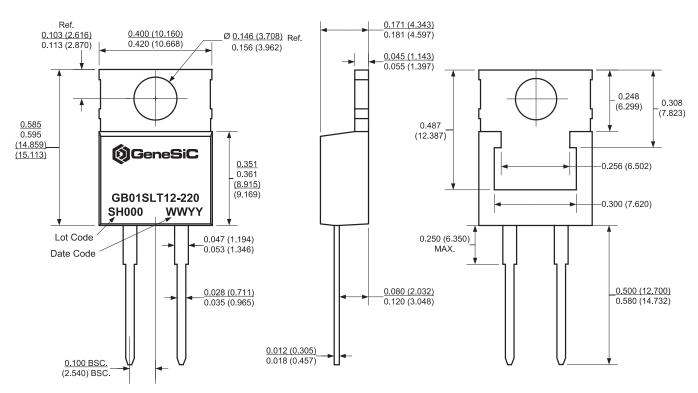


Figure 8: Transient Thermal Impedance

# **Package Dimensions:**

# TO-220AC

#### **PACKAGE OUTLINE**



#### NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments	Supersedes		
2013/02/05	2	Second generation update			
2012/05/22	1	Second generation release			
2010/12/13	0	Initial release			

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## **SPICE Model Parameters**

Copy the following code into a SPICE software program for simulation of the GB01SLT12-220 device.

```
MODEL OF GeneSiC Semiconductor Inc.
    $Revision: 1.0
     $Date: 04-SEP-2013
    GeneSiC Semiconductor Inc.
    43670 Trade Center Place Ste. 155
    Dulles, VA 20166
    http://www.genesicsemi.com/index.php/sic-products/schottky
    COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
    ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB01SLT12-220 SPICE Model
.SUBCKT GB01SLT12 ANODE KATHODE
R1 ANODE INT R=((TEMP-24)*0.0069); Temperature Dependant Resistor
D1 INT KATHODE GB01SLT12 25C; Call the 25C Diode Model
D2 ANODE KATHODE GB01SLT12 PIN; Call the PiN Diode Model
.MODEL GB01SLT12 25C D
+ IS
         7.27E-19
                                    0.592251
                          RS
+ N
         1
                         IKF
                                    407.773
+ EG
         1.2
                         XTI
+ CJO
                                    0.367
         7.90E-11
                         VJ
+ M
         1.63
                         FC
                                    0.5
+ TT
        1.00E-10
1.00E-03
                         BV
                                    1500
+ IBV
                         VPK
                                    1200
+ IAVE
                                    SiC Schottky
                          TYPE
      GeneSiC Semiconductor
+ MFG
.MODEL GB01SLT12 PIN D
+ IS
         1.08E-17
                                    1.8
                          RS
+ N
         2.2313
                                    999
                         IKF
+ EG
         3.23
                         XTI
                                    -65
         0.5
+ FC
                         TT
+ BV
         1500
                         IBV
                                    1.00E-03
+ VPK
         1200
                         IAVE
+ TYPE SiC PiN
.ENDS
```

\* End of GB01SLT12-220 SPICE Model